



APPLICANT: Min-Hsiung Chiang

EXAMINER:

Chacko Davis, Daborah

SERIAL NO.: 10/081,479

ART UNIT:

1756

FILED:

02/21/2002

ATTY DKT NO.: 67,200-576

TITLED:

A SINGLE LAYER WIRING BOND PAD WITH OPTIMUM AL FILM THICKNESS

IN CU/FSG PROCESS FOR DEVICES UNDER PADS

CERTIFICATE OF MAILING

Please forward all correspondence to:

TUNG & ASSOCIATES Suite 120 838 W. Long Lake Road Bloomfield Hills, MI 48302 I hereby certify that this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450

Alexandria, VA 22343-1450, on June 28/

Kathy Dixon

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE UNDER 37 C.F.R. §1.111

Dear Sir:

In response to the Notice of Non-Compliant Amendment dated June 4, 2004, please substitute the following "Claim Amendments" section (replacing the 4/19/04 claims), as follows. The Commissioner is hereby authorized to charge Deposit Account No. 50-0484 any fee due as a result of this response.